

## Features

- Current:5-300A,Voltage:100-1600V
- All models feature the same compact dimensions to Provide auniform mounting pitch
- Glass passivated diode chip
- Excellent power/volume ratio,High thermal conductivity Package, electrically insulated case

|             |           |
|-------------|-----------|
| $I_{F(AV)}$ | 5-50A     |
| $V_{RRM}$   | 100-1600V |
| $V_F$       | 1.1V      |
| $I_{FSM}$   | 175A      |

## Typical Applications

- Eliminator supply,industrial automatic control
- Numierial-controlled machinery,telecontrol system

| SYMBOL        | CHARACTERISTIC                       | TEST CONDITIONS                                                               | VALUE |      | UNIT |
|---------------|--------------------------------------|-------------------------------------------------------------------------------|-------|------|------|
|               |                                      |                                                                               | Min   | Max  |      |
| $I_{F(AV)}$   | Mean forward current                 | 180 ° sine wave, 50HZ<br>Double side cooled, THS=55°C                         | 5     | 50   | A    |
| $V_{RRM}$     | Repetitive peak reverse voltage      | $V_{DRM} \& V_{RRM} t_p=10ms$<br>$V_{DSM} \& V_{RSM}=V_{DRM} \& V_{RRM}+100V$ | 100   | 1600 | V    |
| $V_{RMS}$     | RMS current                          |                                                                               | 70    | 860  | V    |
| $V_{DC}$      | DC blocking voltage                  |                                                                               | 100   | 1600 | V    |
| $I_{FSM}$     | Surge on-state current               | sine wave                                                                     |       | 175  | A    |
| $V_F$         | Diode forward voltage                | $I_F=17.5A$                                                                   |       | 1.1  | V    |
| $I_R$         | Reverse leakage current              | $T_a=25^\circ C$                                                              |       | 10   | uA   |
| $I_{R(H)}$    |                                      | $T_a=100^\circ C$                                                             |       | 200  | uA   |
| $R_{th(j-c)}$ | Thermal impedance node to the shell  | 180 ° sine wave, single heat sink                                             |       | 5.0  | °C/W |
| $R_{th(c-a)}$ | Thermal impedance ( shell to powder) | 180 ° sine wave, single heat sink                                             |       | 8    | °C/W |
| $V_{iso}$     | Insulation voltage                   |                                                                               | 2500  |      | V    |
| $T_J$         | Stored temperature                   |                                                                               | -40   | 125  | °C   |
| $T_{stq}$     | Stored temperature                   |                                                                               | -40   | 150  | °C   |
| $W_t$         | Weight                               |                                                                               |       | 47   | g    |
| Outline       |                                      |                                                                               |       |      |      |

Outline:

Product picture:

